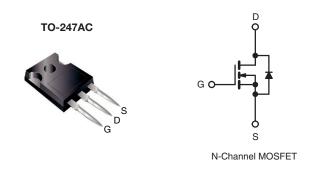
Vishay Siliconix

COMPLIANT

FREE

## **E Series Power MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	700			
R <sub>DS(on)</sub> max. at 25 °C (Ω)	V <sub>GS</sub> = 10 V 0.145			
Q <sub>g</sub> max. (nC)	122			
Q <sub>gs</sub> (nC)	21			
Q <sub>gd</sub> (nC)	37			
Configuration	Single			



#### **FEATURES**

- Low Figure-of-Merit (FOM) Ron x Qq
- Low Input Capacitance (Ciss)
- Reduced Switching and Conduction Losses
- Ultra Low Gate Charge (Q<sub>q</sub>)
- Avalanche Energy Rated (UIS)
- Material categorization: For definitions please see <u>www.vishav.com/doc?99912</u>

#### **APPLICATIONS**

- Server and Telecom Power Supplies
- Switch Mode Power Supplies (SMPS)
- Power Factor Correction Power Supplies (PFC)
- Lighting
  - High-Intensity Discharge (HID)
  - Fluorescent Ballast Lighting
- Industrial
  - Welding
  - Induction Heating
  - Motor Drives
  - Battery Chargers
  - Renewable Energy
  - Solar (PV Inverters)

ORDERING INFORMATION				
Package	TO-247AC			
Lead (Pb)-free	SiHG24N65E-E3			
Lead (Pb)-free and Halogen-free	SiHG24N65E-GE3			

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted)					
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V <sub>DS</sub>	650		
Gate-Source Voltage		.,,	± 20	V	
Gate-Source Voltage AC (f > 1 Hz)		$V_{GS}$	30		
Continuous Drain Current (T <sub>.I</sub> = 150 °C)	$V_{GS}$ at 10 V $T_{C} = 25 ^{\circ}C$ $T_{C} = 100 ^{\circ}C$	l <sub>D</sub>	24	А	
Continuous Drain Current (1 <sub>J</sub> = 150 °C)	$T_C = 100 ^{\circ}$ C		16		
Pulsed Drain Current <sup>a</sup>	I <sub>DM</sub>	70			
Linear Derating Factor		2	W/°C		
Single Pulse Avalanche Energy <sup>b</sup>	E <sub>AS</sub>	508	mJ		
Maximum Power Dissipation	$P_{D}$	250	W		
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C		
Drain-Source Voltage Slope	T <sub>J</sub> = 125 °C dV/dt		37	V/ns	
Reverse Diode dV/dt <sup>d</sup>	uv/ul	11	V/IIS		
Soldering Recommendations (Peak Temperature) for 10 s			300c	°C	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_q$  = 25  $\Omega$ ,  $I_{AS}$  = 6 A.
- c. 1.6 mm from case.
- d.  $I_{SD} \le I_D$ , dI/dt = 100 A/ $\mu$ s, starting  $T_J = 25$  °C.



# Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62	°C/W	
Maximum Junction-to-Case (Drain)	$R_{thJC}$	-	0.5	C/ VV	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub>	= 0 V, I <sub>D</sub> = 250 μA	650	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I <sub>D</sub> = 250 μA	-	0.72	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2	-	4	V
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
7 0 1 1/1 5 1 0 1		V <sub>DS</sub> =	V <sub>DS</sub> = 650 V, V <sub>GS</sub> = 0 V		-	1	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 520 \	/, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 12 A	-	0.120	0.145	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>D</sub>	<sub>S</sub> = 8 V, I <sub>D</sub> = 5 A	-	7.1	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V,	-	2740	-	pF
Output Capacitance	C <sub>oss</sub>	1	$V_{DS} = 100 V,$	-	122	-	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1 MHz		-	4	-	
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>	V <sub>DS</sub> = 0 V to 520 V, V <sub>GS</sub> = 0 V		-	93	-	
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>			-	352	-	
Total Gate Charge	$Q_{g}$	V <sub>GS</sub> = 10 V I <sub>D</sub> = 12 A, V <sub>DS</sub> = 520 V		-	81	122	
Gate-Source Charge	$Q_{gs}$			-	21	-	nC
Gate-Drain Charge	$Q_{gd}$				37	-	
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD} = 520 \text{ V}, I_D = 12 \text{ A}, V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		-	24	48	
Rise Time	t <sub>r</sub>			-	84	126	ns
Turn-Off Delay Time	t <sub>d(off)</sub>			-	70	105	113
Fall Time	t <sub>f</sub>			-	69	104	
Gate Input Resistance	R <sub>g</sub>	f = 1 MHz, open drain		-	0.68	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	24	A
Pulsed Diode Forward Current	I <sub>SM</sub>			-	-	96	
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 12 A, V <sub>GS</sub> = 0 V		-	-	1.2	V
Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = I_S = 12 \text{ A},$ $dI/dt = 100 \text{ A/µs}, V_R = 20 \text{ V}$		-	517	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>			_	9.7	-	μC
Reverse Recovery Current	I <sub>RBM</sub>				30		A

### Notes

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ . b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

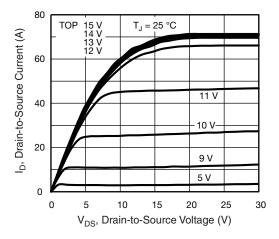


Fig. 1 - Typical Output Characteristics

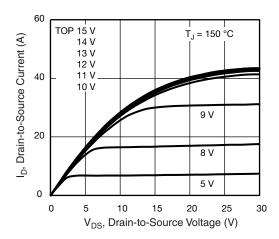


Fig. 2 - Typical Output Characteristics

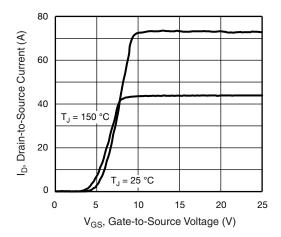


Fig. 3 - Typical Transfer Characteristics

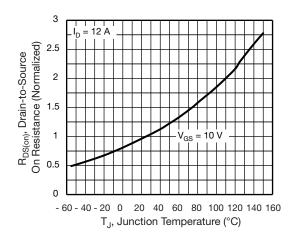


Fig. 4 - Normalized On-Resistance vs. Temperature

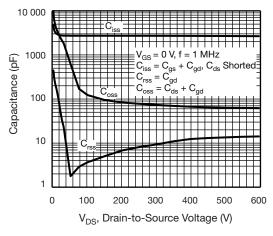


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

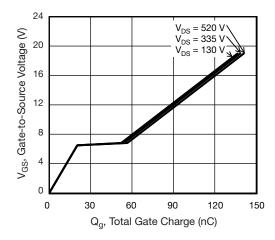


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



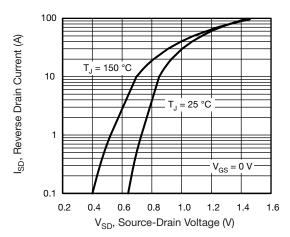


Fig. 7 - Typical Source-Drain Diode Forward Voltage

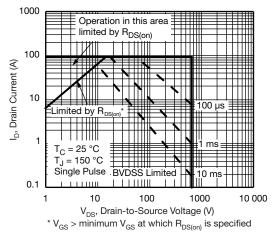


Fig. 8 - Maximum Safe Operating Area

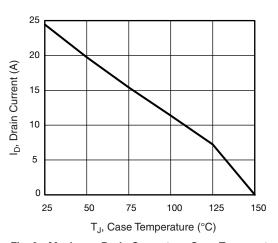


Fig. 9 - Maximum Drain Current vs. Case Temperature

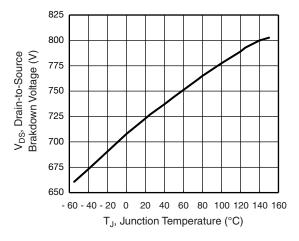


Fig. 10 - Temperature vs. Drain-to-Source Voltage

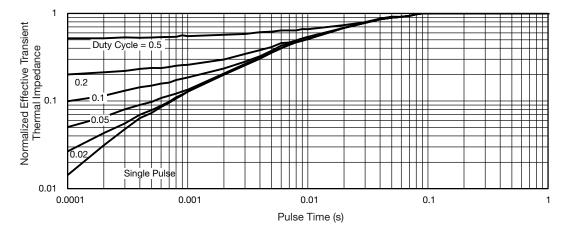


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



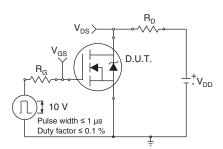


Fig. 12 - Switching Time Test Circuit

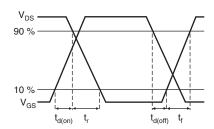


Fig. 13 - Switching Time Waveforms

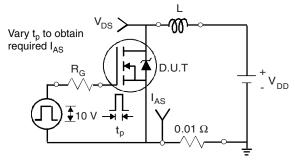


Fig. 14 - Unclamped Inductive Test Circuit

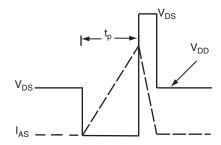


Fig. 15 - Unclamped Inductive Waveforms

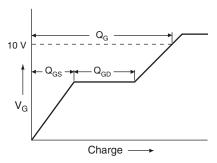


Fig. 16 - Basic Gate Charge Waveform

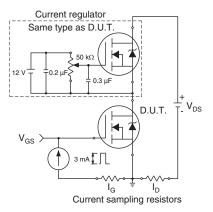
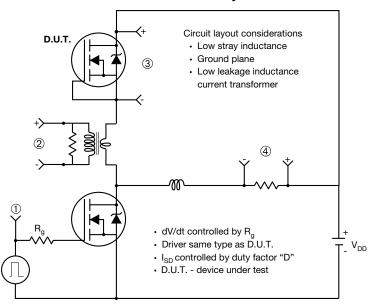


Fig. 17 - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



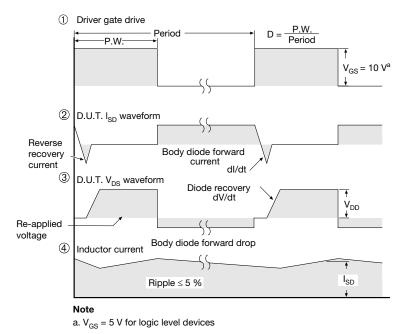


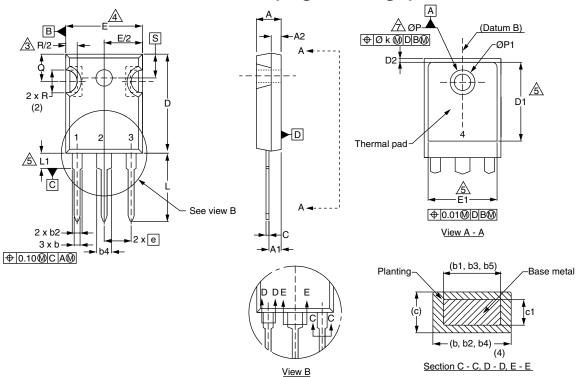
Fig. 18 - For N-Channel

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# **TO-247AC (High Voltage)**



	MILLIM	IETERS	INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.58	5.31	0.180	0.209
A1	2.21	2.59	0.087	0.102
A2	1.17	2.49	0.046	0.098
b	0.99	1.40	0.039	0.055
b1	0.99	1.35	0.039	0.053
b2	1.53	2.39	0.060	0.094
b3	1.65	2.37	0.065	0.093
b4	2.42	3.43	0.095	0.135
b5	2.59	3.38	0.102	0.133
С	0.38	0.86	0.015	0.034
c1	0.38	0.76	0.015	0.030
D	19.71	20.82	0.776	0.820
D1	13.08	ı	0.515	-

	MILLIMETERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
D2	0.51	1.30	0.020	0.051	
Е	15.29	15.87	0.602	0.625	
E1	13.72	-	0.540	-	
е	5.46	BSC	0.215 BSC		
Øk	0.2	0.254		0.010	
L	14.20	16.25	0.559	0.640	
L1	3.71	4.29	0.146	0.169	
N	7.62 BSC		0.300 BSC		
ØΡ	3.51	3.66	0.138	0.144	
Ø P1	-	7.39	-	0.291	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	0.178	0.216	
S	5.51 BSC		0.217	BSC	

ECN: X12-0167-Rev. B, 24-Sep-12

DWG: 5971

#### **Notes**

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Contour of slot optional.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions D1 and E1.
- 5. Lead finish uncontrolled in L1.
- 6. Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154").
- 7. Outline conforms to JEDEC outline TO-247 with exception of dimension c.
- 8. Xian and Mingxin actually photo.



Revision: 24-Sep-12 1 Document Number: 91360



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Vishay

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